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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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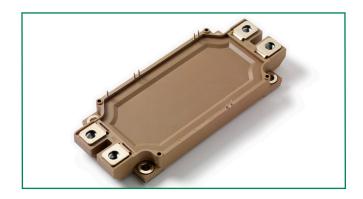






## MG06600WB-BN4MM





#### **Features**

- High short circuit capability, self limiting short circuit current
- V<sub>CE(sat)</sub> with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Low switching losses

### **Applications**

- High frequency switching application
- Medical applications
- Motion/servo control supplies
- UPS systems

### Module Characteristics (T<sub>J</sub> = 25°C, unless otherwise specified)

Symbol	Parameters	Test Conditions	Min	Тур	Max	Unit
T <sub>J max</sub>	Max. Junction Temperature				175	°C
T <sub>J op</sub>	Operating Temperature		-40		150	°C
T <sub>stg</sub>	Storage Temperature		-40		125	°C
V <sub>isol</sub>	Insulation Test Voltage	AC, t=1min		3000		V
CTI	Comparative Tracking Index		250			
Torque	Module-to-Sink	Recommended (M5)	2.5		5	N⋅m
Torque	Module Electrodes	Recommended (M6)	3		5	N⋅m
Weight				350		g

#### Absolute Maximum Ratings (T<sub>1</sub> = 25°C, unless otherwise specified)

Symbol	Parameters	Test Conditions	Values	Unit		
IGBT						
V <sub>CES</sub>	Collector - Emitter Voltage	T <sub>J</sub> =25°C	600	V		
V <sub>GES</sub>	Gate - Emitter Voltage		±20	V		
1	DC Collector Current	T <sub>C</sub> =25°C	700	А		
'c	De collector current	T <sub>C</sub> =50°C	600	А		
	Repetitive Peak Collector Current	t <sub>p</sub> =1ms	1200	А		
P <sub>tot</sub>	Power Dissipation Per IGBT		1500	W		
Diode						
V <sub>RRM</sub>	Repetitive Reverse Voltage	T <sub>J</sub> =25°C	600	V		
	Average Forward Current	T <sub>c</sub> =25°C	700	А		
F(AV)	Average Follward Current	T <sub>C</sub> =50°C	600	А		
I <sub>FRM</sub>	Repetitive Peak Forward Current	t <sub>p</sub> =1ms	1200	А		
l <sup>2</sup> t		$T_{J} = 125^{\circ}\text{C}, t = 10\text{ms}, V_{R} = 0\text{V}$	17000	A <sup>2</sup> s		

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### Electrical and Thermal Specifications (T<sub>J</sub> = 25°C, unless otherwise specified)

Symbol	Parameters	Test Conditions		Min	Тур	Max	Unit
IGBT							
$V_{\text{GE(th)}}$	Gate - Emitter Threshold Voltage	$V_{CE}=V_{GE}$ , $I_{C}=9.6$ mA		4.9	5.8	6.5	V
	Collector - Emitter	I <sub>C</sub> =600A, V <sub>GF</sub> =15V, T <sub>J</sub> =25°C			1.45		V
V <sub>CE(sat)</sub>	Saturation Voltage	I <sub>C</sub> =600A, V <sub>GE</sub> =	15V, T <sub>J</sub> =125°C		1.6		V
	Collector Lockego Current	V <sub>CE</sub> =600V, V <sub>GE</sub>	=0V, T <sub>J</sub> =25°C			1	mA
I <sub>ICES</sub>	Collector Leakage Current	$V_{CE}$ =600V, $V_{GE}$	=0V, T <sub>J</sub> =125°C			5	mA
I <sub>GES</sub>	Gate Leakage Current	$V_{CE}=0V, V_{GE}=\pm$	15V, T <sub>J</sub> =125°C	-400		400	nA
$R_{\text{Gint}}$	Integrated Gate Resistor				0.68		Ω
Q <sub>ge</sub>	Gate Charge	V <sub>CE</sub> =300V, I <sub>C</sub> =600A , V <sub>GE</sub> =±15V			6.5		μC
C <sub>ies</sub>	Input Capacitance	\/ -25\/\/	OV/ f _1N/U¬		39		nF
C <sub>res</sub>	Reverse Transfer Capacitance	$V_{CE}$ =25V, $V_{GE}$ =0V, f =1MHz			1.15		nF
t	Turn - on Delay Time		T <sub>J</sub> =25°C		100		ns
t <sub>d(on)</sub>	ram on Belay mine		T <sub>J</sub> =125°C		110		ns
t,	Rise Time		T <sub>J</sub> =25°C		90		ns
r	THISOTHING	V <sub>cc</sub> =300V	T <sub>J</sub> =125°C		95		ns
t <sub>d(off)</sub>	Turn - off Delay Time	I <sub>c</sub> =600A	T <sub>J</sub> =25°C		670		ns
d(off)	Tann on Doily Time	$R_{\rm G} = 2.4\Omega$	T <sub>J</sub> =125°C		710		ns
t,	Fall Time	$V_{GF} = \pm 15V$	T <sub>J</sub> =25°C		70		ns
-f		Inductive Load	T <sub>J</sub> =125°C		75		ns
E <sub>on</sub>	Turn - on Energy	muuctive Load	T <sub>J</sub> =25°C		8.9		mJ
_on			T <sub>J</sub> =125°C		9.9		mJ
E <sub>off</sub>	Turn - off Energy		T <sub>J</sub> =25°C		21.5		mJ
оп			T <sub>J</sub> =125°C		25		mJ
l <sub>sc</sub>	Short Circuit Current	$t_{psc} \le 6\mu S$ , $V_{GE} = 15V$ ; $T_{J} = 125^{\circ}C$ , $V_{CC} = 360V$			3000		Α
$R_{thJC}$	Junction-to-Case Th	ermal Resistance (Per			0.10	K/W	
Diode				1	1		
V <sub>F</sub>	Forward Voltage	$I_{\rm F}$ =600A, $V_{\rm GE}$ =0V, $T_{\rm J}$ =25°C			1.55		V
	-	$I_{\rm F}$ =600A, $V_{\rm GE}$ =0V, $T_{\rm J}$ =125°C			1.5		V
t <sub>RR</sub>	Reverse Recovery Time	I <sub>F</sub> =600A, V <sub>R</sub> =300V			400		ns
I <sub>RRM</sub>	Max. Reverse Recovery Current	di <sub>p</sub> /dt=-6000A/μs			300		A
E <sub>rec</sub>	Reverse Recovery Energy	T <sub>J</sub> =125°C			9.3		mJ
R <sub>thJCD</sub>	Junction-to-Case Th	ermal Resistance (Per I	Diode)			0.16	K/W

### NTC Characteristics (T<sub>J</sub> = 25°C, unless otherwise specified)

Symbol	Parameters	Test Conditions	Min	Тур	Max	Unit
R <sub>25</sub>	Resistance	T <sub>c</sub> =25°C		5		ΚΩ
B <sub>25/50</sub>				3375		K

Figure 1: Typical Output Characteristics for IGBT Inverter

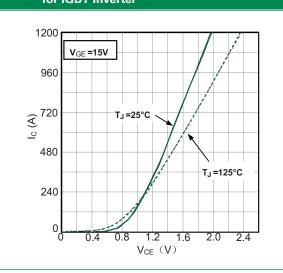


Figure 3: Typical Transfer Characteristics for IGBT Inverter

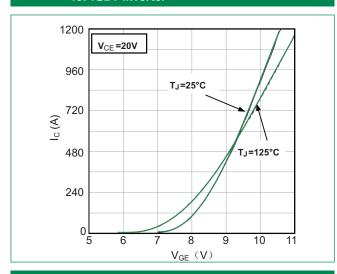


Figure 5: Switching Energy vs. Collector Current for IGBT Inverter

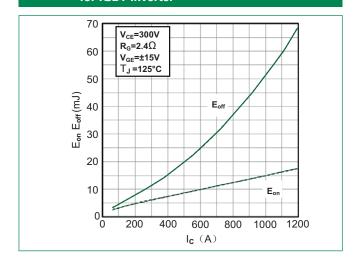


Figure 2: Typical Output Characteristics for IGBT Inverter

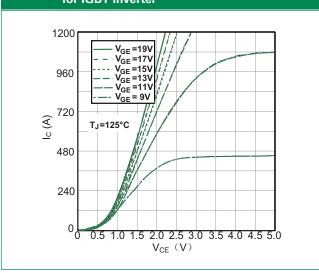


Figure 4: Switching Energy vs. Gate Resistor for IGBT Inverter

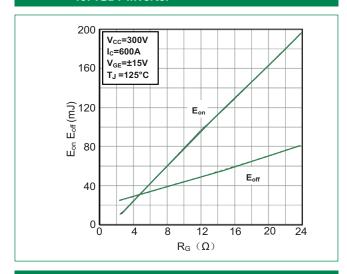


Figure 6: Reverse Biased Safe Operating Area for IGBT Inverter

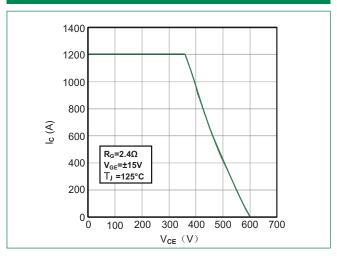


Figure 7: Diode Forward Characteristics for Diode Inverter

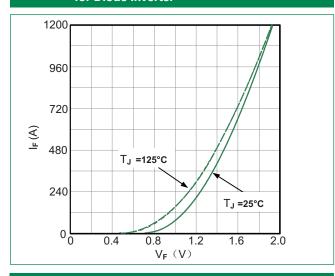
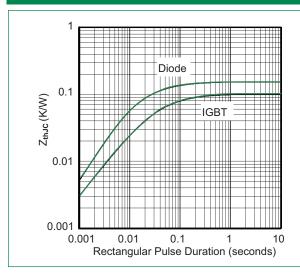


Figure 9: Transient Thermal Impedance of Diode and IGBT Inverter



**Circuit Diagram** 

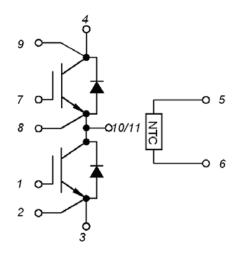
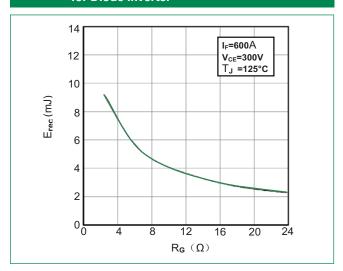
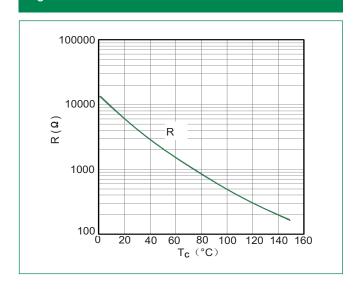


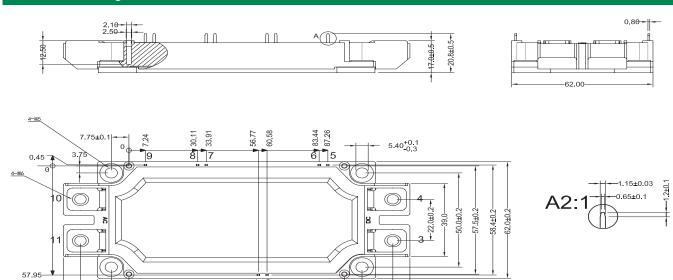
Figure 8: Switching Energy vs. Gate Resistort for Diode Inverter



**Figure 10: NTC Characteristics** 



#### **Dimensions-Package WB**



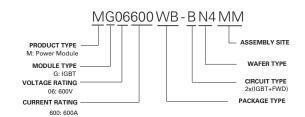
The foot pins are in gold / nickel coating

-94.5±0.2--110.0±0.5--122.0±0.5--137.0±0.5 -152.0±0.5-

#### **Packing Options**

Part Number	Marking	Weight	Packing Mode	M.O.Q
MG06600WB-BN4MM	MG06600WB-BN4MM	350g	Bulk Pack	60

### **Part Numbering System**



### **Part Marking System**

